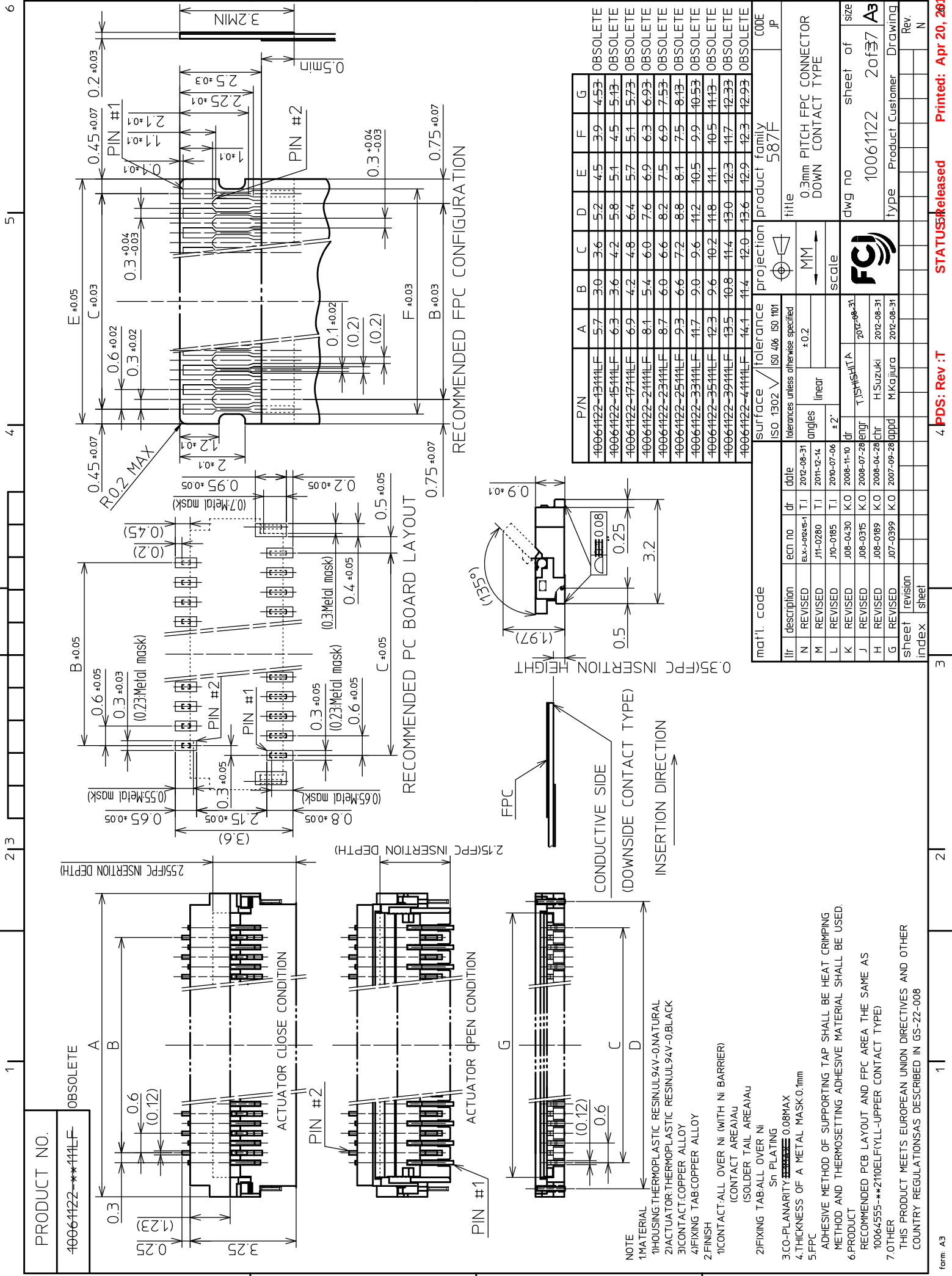




NOTE	MIN OF CONTACT
1.CO-PLANARITY:0.08mm/MAX	
2.THICKNESS OF A METAL MASK:0.1mm	
3.FPC	

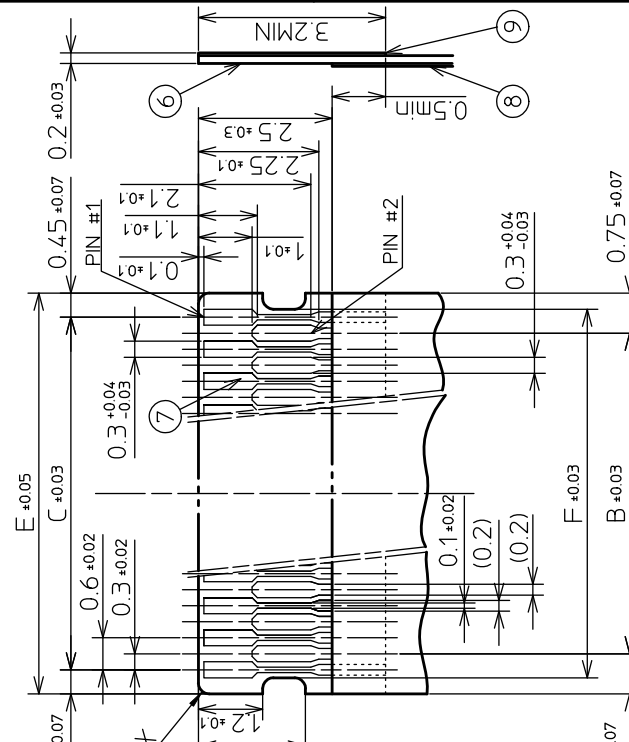
Adhesive method of supporting tape shall be heat crimping method and thermosetting adhesive material shall be used.

4.PRODUCT

5.OTHER

This product meets European Union Directives and other country regulation as described in GS-22-008

Recommended PCB layout and PFC area the same as 10064555-***2110•LYLL-Upper contact types



	PARTS NAME	MATERIAL	QTY	REMARKS
6	BASE FILM	POLYAMDE	1	
7	CONDUCTOR	COPPER FOIL	n	[PLATING] ALL OVER Ni 4-12 μ m, AU 0.05-0.15 μ m
8	OVERLAY	POLYAMIDE	1	
9	STIFFENER	POLYAMIDE	1	

	P/N	A	B	C	D	E	F
	10061122-27132HLF	9.9	7.2	7.8	9.4	8.7	8.1
	10061122-29132HLF	10.5	7.8	8.4	10.0	9.3	8.7
	10061122-35132HLF	11.7	9.0	9.6	11.2	10.5	9.9
	10061122-33132HLF	12.3	9.6	10.2	11.8	11.1	10.5
	10061122-39132HLF	13.5	10.8	11.4	13.0	12.3	11.7
	10061122-41132HLF	14.1	11.4	12.0	13.6	12.9	12.3
	10061122-45132HLF	15.3	12.6	13.2	14.8	14.1	13.5

mat'l. code				surface / tolerance		projection		product family		CODE	
l/r	description	ecn no	dr	date	ISO 1302	ISO 406	ISO 1101		587F (YLL-D)		JP
A	Released	J10-0185	T.I	2010-07-06	tolerances unless otherwise specified			title 0.3mm PITCH FPC CONNECTOR DOWN CONTACT TYPE			
B	Revised	J10-0268	T.I	2010-10-12	linear						
C	Revised	ELX-J-0245-1	T.I	2012-08-31	± 0.2						
			dr		T.I		scale		dwg no		sheet of
			engr		T.I				10061122		6 of 7
			chr		H Suzuki				type		Product Customer
			appd		M.Kajijura				Drawing		Rev.
sheet	revision										
index	sheet										

